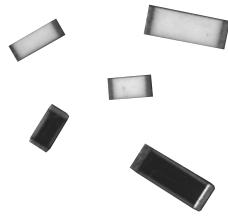
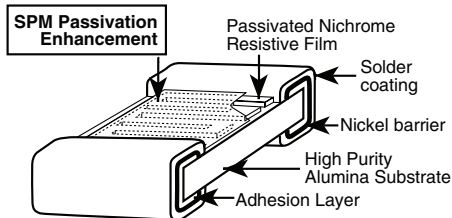


Commercial Thin Film Chip Resistors


**Actual Size
0505**

For applications requiring low noise, stability, low temperature coefficient of resistance, and low voltage coefficient, all VISHAY's proven precision thin film wraparound resistors will meet your exact requirements. Manufactured with the same material and processes as QPL and manufactured in a QPL facility.

CONSTRUCTION



FEATURES

- Lead (Pb)-free or Sn/Pb terminations available
- Moisture resistant (SPM) special passivation method
- Non-standard values available
- Pre-tinned terminations over nickel barrier (Gold available)
- Very low noise and voltage coefficient (< - 30 dB, 0.1 ppm/V)
- Non-inductive
- Laser-trimmed tolerances to 0.02 %
- In-lot tracking less than 5 ppm/°C


RoHS*
COMPLIANT

**SURFACE MOUNT
CHIPS**

TYPICAL PERFORMANCE

	ABS
TCR	25
TOL	0.1

STANDARD ELECTRICAL SPECIFICATIONS

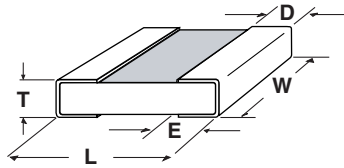
TEST	SPECIFICATIONS	CONDITIONS
Material	Passivated Nichrome	
Absolute TCR	± 25 ppm/°C (available to ± 10 ppm/°C)	- 55 °C to + 125 °C
Absolute Tolerance	± 0.1 % (available to ± 0.02 %)	+ 25 °C
Power Rating	see table	
Voltage Coefficient	0.1 ppm/V typical	
Working Voltage	see table	
Operating Temperature Range	- 55 °C to + 125 °C	
Storage Temperature Range	- 55 °C to + 150 °C	
Noise	< - 35 dB typical	

CASE SIZE	POWER RATING - (mW)		MAX WORKING VOLTAGE		RESISTANCE RANGE - (Ω)	
	≥ 0.1 %	< 0.1 %	≥ 0.1 %	< 0.1 %	≥ 0.1 %	< 0.1 %
0402	50	50	75	75	25 - 75K	250 - 70K
0502	100	100	75	75	20 - 130K	250 - 130K
0505	150	150	75	75	20 - 301K	250 - 301K
0603	150	150	75	75	10 - 175K	250 - 175K
0805, 0705	250	200	100	100	10 - 475K	250 - 475K
1005	250	250	100	100	10 - 649K	250 - 649K
1010	500	500	150	100	50 - 1M	250 - 1M
1206	400	400	200	200	10 - 1M	250 - 1M
1505	400	400	150	150	10 - 1M	250 - 1M
2208	800	750	150	150	10 - 1.75M	250 - 1M
2010	800	750	200	150	10 - 2M	250 - 1M
2512	1000	750	200	200	10 - 3M	250 - 1M

* Pb containing terminations are not RoHS compliant, exemptions may apply



DIMENSIONS in inches

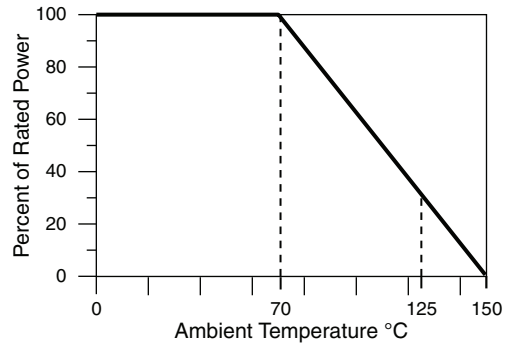


SURFACE MOUNT CHIPS

CASE SIZE	TERM	L	W	T	D	E
0402	B	0.042 ± 0.008	0.022 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.010 ± 0.005
0502	B	0.055 ± 0.006	0.025 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.015 ± 0.005
0505	B	0.055 ± 0.006	0.050 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.015 ± 0.005
0603	B	0.064 ± 0.006	0.032 ± 0.005	0.020 Max.	0.012 ± 0.005	0.015 ± 0.005
0805, 0705	B	0.080 ± 0.006	0.050 ± 0.005	0.015 to 0.033	0.016 ± 0.008	0.015 ± 0.005
1005	B	0.105 ± 0.007	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
1010	B	0.105 ± 0.007	0.100 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
1206	B	0.126 ± 0.008	0.063 ± 0.005	0.015 to 0.033	0.020 + 0.005, - 0.010	0.020 + 0.005, 0.010
1505	B	0.155 ± 0.007	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
2010	B	0.209 ± 0.009	0.098 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005
2208	B	0.230 ± 0.007	0.075 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005
2512	B	0.259 ± 0.009	0.124 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005

ENVIRONMENTAL TESTS		
Environmental Test	10 kΩ ΔR ± (%)	100 kΩ ΔR ± (%)
Thermal Shock	0.02	0.02
Short Time Overload	0.01	0.01
Low Temperature Operation	0.01	0.01
Resistance to Solder Heat	0.04	0.03
Moisture Resistance	0.02	0.01
High Temperature Exposure	0.03	0.06
Load life (10 000 h, + 70 °C)	0.05	0.05
TCR	± 25 ppm/°C	± 25 ppm/°C

DERATING CURVE



GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: P-1206E1002BBTS (preferred part number format)

P	-	1	2	0	6	E	1	0	0	2	B	B	T	S
GLOBAL MODEL	CASE SIZE	TCR CHARACTERISTIC				RESISTANCE	TOLERANCE	TERMINATION				PACKAGING		
P-	0402 0502 0505 0603 0805 1005 1010 1206 1505 2208 2010 2512	Y = ± 10 ppm/°C* D = ± 15 ppm/°C E = ± 25 ppm/°C** H = ± 50 ppm/°C K = ± 100 ppm/°C * > 250 Ω ** > 25 Ω				The first 3 digits are significant figures and the last digit specifies the number of zeros to follow. "R" designates the decimal point. Example: 10R0 = 10 Ω 1001 = 1 kΩ 1002 = 10 kΩ	Q = ± 0.02 %* A = ± 0.05 %* B = ± 0.1 % D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 % * For values ≥ 1 kΩ	B = Wraparound Sn/Pb Solder 63 % Sn/37 % Pb w/ Nickel Barrier G = Wraparound Au over Ni (Gold) Termination Epoxy Solderable RoHS compliant - e4 S = Wraparound Lead (Pb)-free Solder 96.5 % Sn/3.0 % Ag/ 0.5 % Cu RoHS compliant - e1				BS = BULK 100 Min 1 Mult WS = WAFFLE 100 Min 1 Mult TAPE AND REEL T0 = 100 Min 100 Mult T1 = 1000 Min 1000 Mult T3 = 300 Min 300 Mult T5 = 500 Min 500 Mult TF = Full Reel TS = 100 Min 1 Mult		

Historical Part Number Example: P0805H6801BBT

P	0805	H	6801	B	B	T
STYLE	CASE SIZE	TCR CHARACTERISTIC	OHMIC VALUE	TOLERANCE	TERMINATION	PACKAGING



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